# XN05531 (XN5531)

### Silicon NPN epitaxial planer transistor

For high frequency oscillation and mixing

#### Features

- Two elements incorporated into one package.
- Reduction of the mounting area and assembly cost by one half.

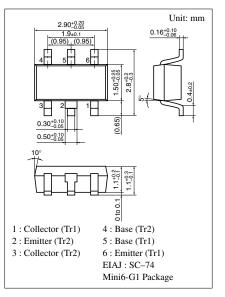
#### Basic Part Number of Element

•  $2SC3130 \times 2$  elements

Parameter		Symbol	Ratings	Unit
Rating of element	Collector to base voltage	V <sub>CBO</sub>	15	V
	Collector to emitter voltage	V <sub>CEO</sub>	10	V
	Emitter to base voltage	V <sub>EBO</sub>	3	V
	Collector current	I <sub>C</sub>	50	mA
Overall	Total power dissipation	P <sub>T</sub>	200	mW
	Junction temperature	$T_j$	150	°C
	Storage temperature	T <sub>stg</sub>	-55 to +150	°C

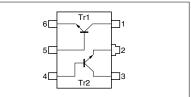
#### Absolute Maximum Ratings (Ta=25°C)

Electrical Characteristics (Ta=25°C)



#### Marking Symbol: 5M

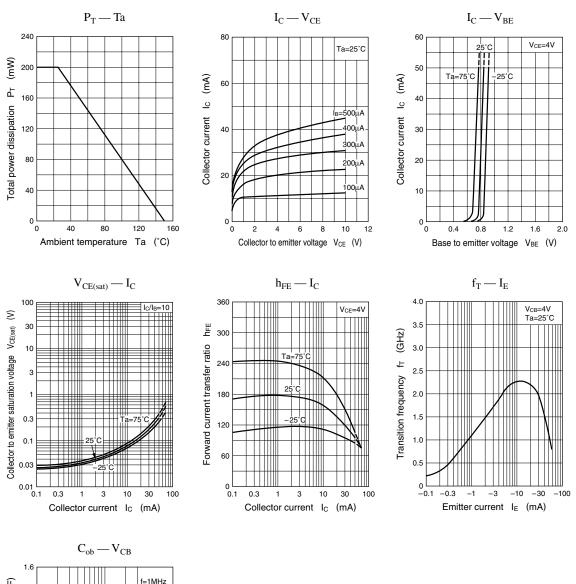
#### Internal Connection

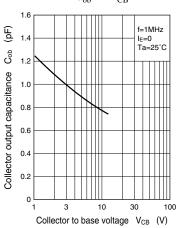


#### Parameter Symbol Conditions Unit min typ max Collector to emitter voltage V<sub>CEO</sub> $I_{C} = 2mA, I_{B} = 0$ 10 V V<sub>EBO</sub> $I_{E} = 10 \mu A$ , $I_{C} = 0$ 3 V Emitter to base voltage $V_{CB} = 10V, I_E = 0$ 1 $I_{CBO}$ μΑ Collector cutoff current $V_{CE} = 10V, I_B = 0$ 10 I<sub>CEO</sub> μΑ Forward current transfer ratio h<sub>FE1</sub> $V_{CE} = 4V, I_C = 5mA$ 75 200 400 Forward current transfer h<sub>FE</sub> ratio hFE (small/large)\*1 $V_{CE} = 4V, I_{C} = 5mA$ 0.5 0.99 $V_{CE} = 4V, I_C = 100 \mu A$ 0.75 1.6 h<sub>FE2</sub>/h<sub>FE1</sub> ratio h<sub>FE2</sub>/h<sub>FE1</sub> $V_{CE} = 4V, I_{C} = 5mA$ $I_C = 20mA$ , $I_B = 4mA$ 0.5 V Collector to emitter saturation voltage V<sub>CE(sat)</sub> $V_{CB} = 4V, I_E = 0, f = 1MHz$ Collector output capacitance Cob 0.9 1.1 pF $\mathbf{f}_{\mathrm{T}}$ $V_{CB} = 4V, I_E = -5mA, f = 200MHz$ 1.4 1.9 2.5 GHz Transition frequency $V_{CB} = 4V, I_E = -5mA, f = 30MHz$ Collector to base parameter $r_{bb}' \cdot C_C$ 11.8 13.5 ps Common base reverse transfer capacitance $V_{CB} = 4V, I_E = 0, f = 1MHz$ 0.25 0.35 Crb pF

\*1 Ratio between 2 elements

Note) The Part number in the Parenthesis shows conventional part number.





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